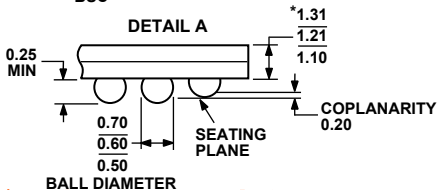
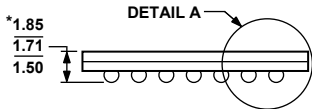
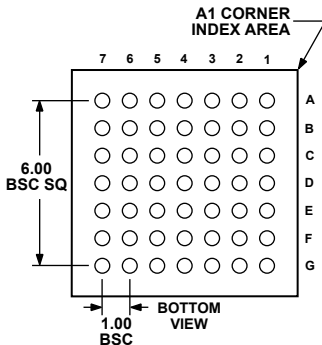
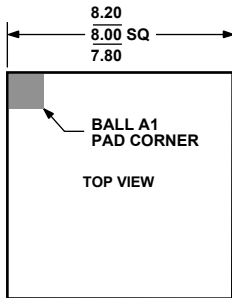


49-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-49-3)

Dimensions shown in millimeters



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COMPLIANT WITH JEDEC STANDARDS MO-152-EB3
WITH EXCEPTION TO PACKAGE HEIGHT AND THICKNESS.